# **Special Issue**

## Al Multimedia Applications

## Message from the Guest Editors

The advance of AI technology has developed the world at a rapid pace. These technologies have created a better environment for people to live in, particularly through multimedia applications and medical signal processing, such as surveillance systems, medical sensors systems, robotics, computer vision systems, image restoration systems, electroencephalogram signal processing, and so In addition, they also involve all kinds of image/vision/camera/acoustic sensors and sensing systems to acquire data for developing and verifying these systems. This Special Issue addresses all types of AI-based multimedia sensors designed to help people understand the world and to live easier.

- Multimedia applications
- Surveillance
- Medical Sensors
- Robotics
- Computer Vision
- Image Restoration

### **Guest Editors**

Prof. Dr. Shih-Chia Huang

Dr. Yan-Tsung Peng

Prof. Dr. Benjamin C. M. Fung

Dr. Cheng Zhang

### Deadline for manuscript submissions

closed (15 September 2022)



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## Message from the Editor-in-Chief

Sensors is a leading journal devoted to fast publication of the latest achievements of technological developments and scientific research in the huge area of physical, chemical and biochemical sensors, including remote sensing and sensor networks. Both experimental and theoretical papers are published, including all aspects of sensor design, technology, proof of concept and application. Sensors organizes Special Issues devoted to specific sensing areas and applications each year.

#### Editor-in-Chief

### Prof. Dr. Vittorio M. N. Passaro

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